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June 8, 2007

Date of Deposit

Mindy N. Rittner, Ph.D. - Reg. No. 57,803

Name of applicant, assignee or Registered Representative

Signature

Date of Signature

Our Case No. 10322/57 Client Ref. No. TF03009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kuang Chien Hsieh et al.

Serial No. 10/680,509

Filing Date: October 7, 2003

For ADHESIVE BONDING WITH LOW

TEMPERATURE GROWN AMORPHOUS OR POLYCRYSTALLINE COMPOUND

SEMICONDUCTORS

Examiner: Hoa B. Trinh

Group Art Unit No. 2814

AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

This communication is in response to the Office action dated March 9, 2007.

Applicants respectfully request that the Examiner reconsider the rejections of the claims in view of the following remarks and amendments.

Amendments to the Claims begin on page 2.

Remarks begin on page 11.